



N-Channel Depletion-Mode Vertical DMOS FET

Features

- ▶ High input impedance
- ▶ Low input capacitance
- ▶ Fast switching speeds
- ▶ Low on-resistance
- ▶ Free from secondary breakdown
- ▶ Low input and output leakage

Applications

- ▶ Normally-on switches
- ▶ Solid state relays
- ▶ Converters
- ▶ Linear amplifiers
- ▶ Constant current sources
- ▶ Power supply circuits
- ▶ Telecom

General Description

These depletion-mode (normally-on) transistors utilize an advanced vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Ordering Information

Device	Package Options		BV _{DSX} /BV _{DGX} (V)	R _{DS(ON)} (max) (Ω)	I _{DSS} (min) (mA)
	TO-92	TO-243AA (SOT-89)			
DN3545	DN3545N3-G	DN3545N8-G	450	20	200

-G indicates package is RoHS compliant ('Green')



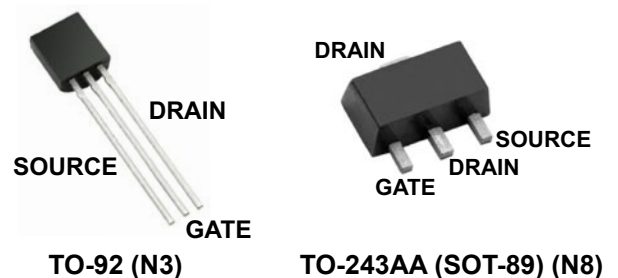
Absolute Maximum Ratings

Parameter	Value
Drain-to-source voltage	BV _{DSX}
Drain-to-gate voltage	BV _{DGX}
Gate-to-source voltage	±20V
Operating and storage temperature	-55°C to +150°C
Soldering temperature*	300°C

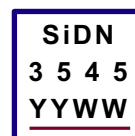
Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

* Distance of 1.6mm from case for 10 seconds.

Pin Configurations



Product Marking



YY = Year Sealed
 WW = Week Sealed
 _____ = "Green" Packaging

Package may or may not include the following marks: Si or

TO-92 (N3)



W = Code for week sealed
 _____ = "Green" Packaging

Package may or may not include the following marks: Si or

TO-243AA (SOT-89) (N8)

Thermal Characteristics

Package	I _D (continuous) [†] (mA)	I _D (pulsed) (mA)	Power Dissipation @T _A = 25°C (W)	θ _{jc} (°C/W)	θ _{ja} (°C/W)	I _{DR} [‡] (mA)	I _{DRM} (mA)
T0-92	136	1600	0.74	125	170	136	1600
TO-243AA	200	300	1.6 [‡]	15	78 [‡]	200	300

Notes:

- [†] I_D (continuous) is limited by max rated T_J.
- [‡] Mounted on FR4 board, 25mm x 25mm x 1.57mm.

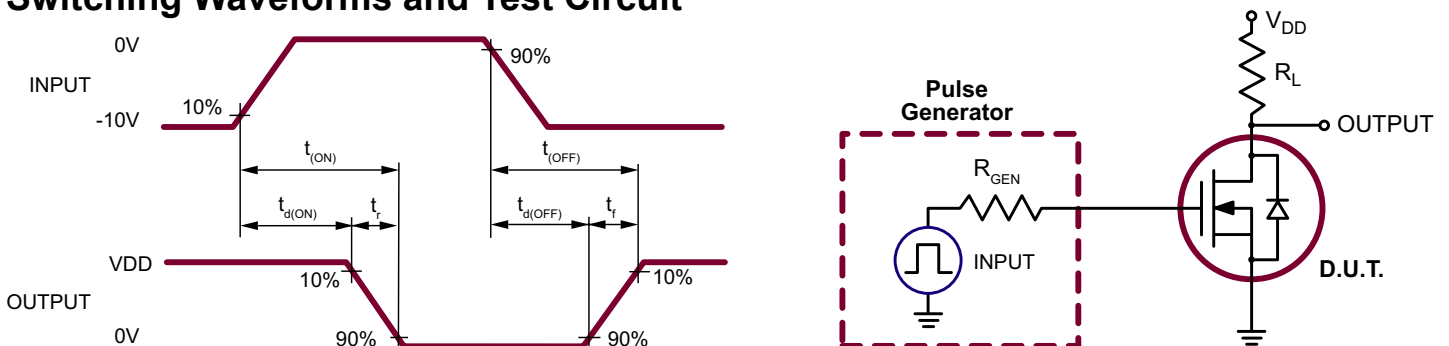
Electrical Characteristics (T_A = 25°C unless otherwise specified)

Sym	Parameter	Min	Typ	Max	Units	Conditions
BV _{DSX}	Drain-to-source breakdown voltage	450	-	-	V	V _{GS} = -5.0V, I _D = 100µA
V _{GS(OFF)}	Gate-to-source off voltage	-1.5	-	-3.5	V	V _{DS} = 25V, I _D = 10µA
ΔV _{GS(OFF)}	Change in V _{GS(OFF)} with temperature	-	-	-4.5	mV/°C	V _{DS} = 25V, I _D = 10µA
I _{GSS}	Gate body leakage current	-	-	100	nA	V _{GS} = ± 20V, V _{DS} = 0V
I _{D(OFF)}	drain-to-source leakage current	-	-	1.0	µA	V _{GS} = -5.0V, V _{DS} = Max Rating
		-	-	1.0	mA	V _{GS} = -5.0V, V _{DS} = 0.8Max Rating T _A = 125°C
I _{DSS}	Saturated drain-to-source current	200	-	-	mA	V _{GS} = 0V, V _{DS} = 15V
R _{DS(ON)}	Static drain-to-source on-state resistance	-	-	20	Ω	V _{GS} = 0V, I _D = 150mA
ΔR _{DS(ON)}	Change in R _{DS(ON)} with temperature	-	-	1.1	%/°C	V _{GS} = 0V, I _D = 150mA
G _{FS}	Forward transductance	150	-	-	mmho	I _D = 100mA, V _{DS} = 10V
C _{ISS}	Input capacitance	-	-	360	pF	V _{GS} = -5.0V, V _{DS} = 25V, f = 1.0MHz
C _{OSS}	Common source output capacitance	-	-	40		
C _{RSS}	Reverse transfer capacitance	-	-	15		
t _{d(ON)}	Turn-on delay time	-	-	20	ns	V _{DD} = 25V, I _D = 150mA, R _{GEN} = 25Ω, V _{GS} = 0V to -10V
t _r	Rise time	-	-	30		
t _{d(OFF)}	Turn-off delay time	-	-	30		
t _f	Fall time	-	-	40		
V _{SD}	Diode forward voltage drop	-	-	1.8	V	V _{GS} = -5.0V, I _{SD} = 150mA
t _{tr}	Reverse recovery time	-	800	-	ns	V _{GS} = -5.0V, I _{SD} = 150mA

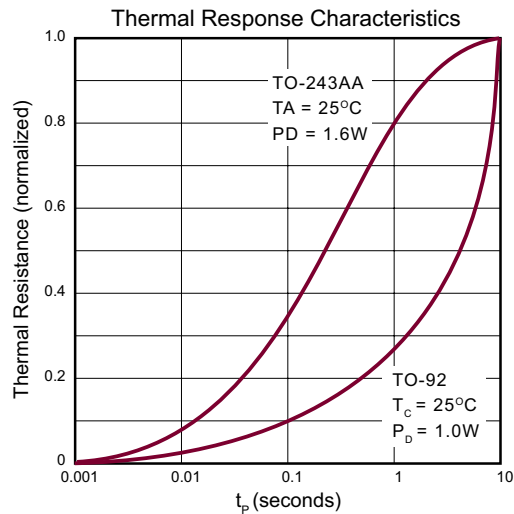
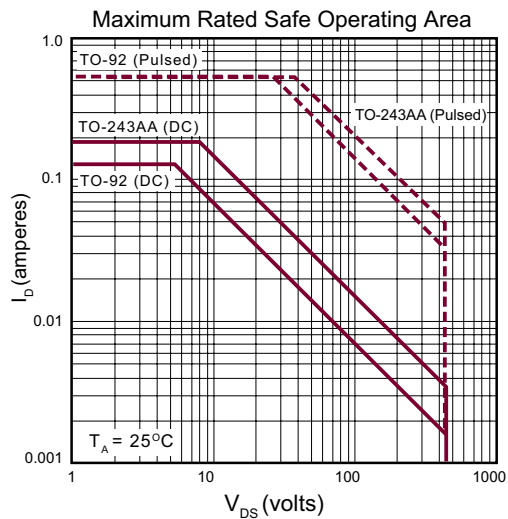
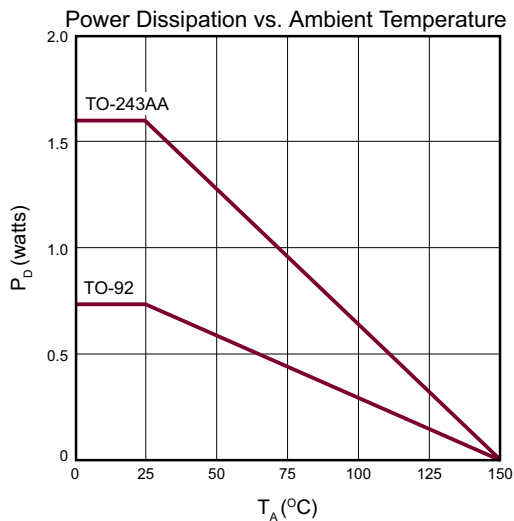
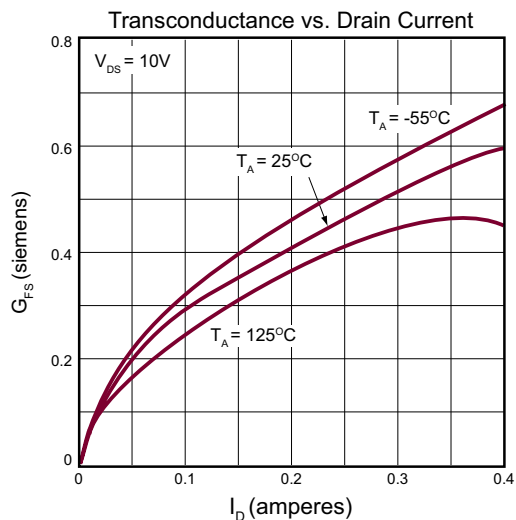
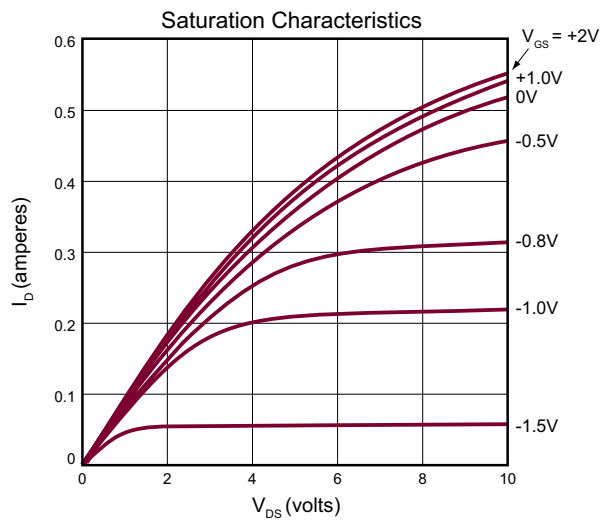
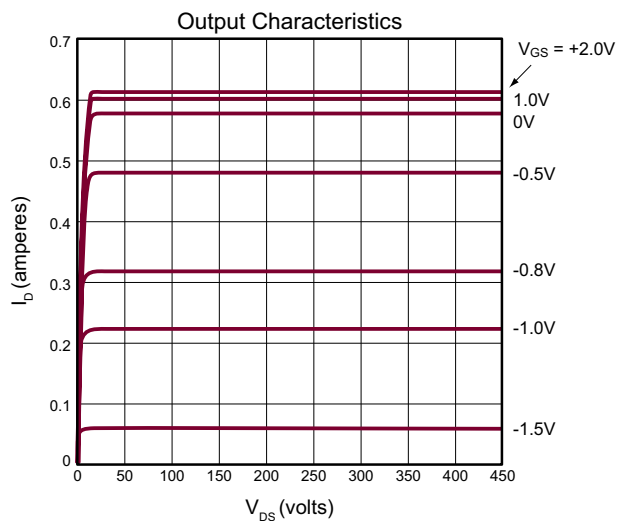
Notes:

- All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.)
- All A.C. parameters sample tested.

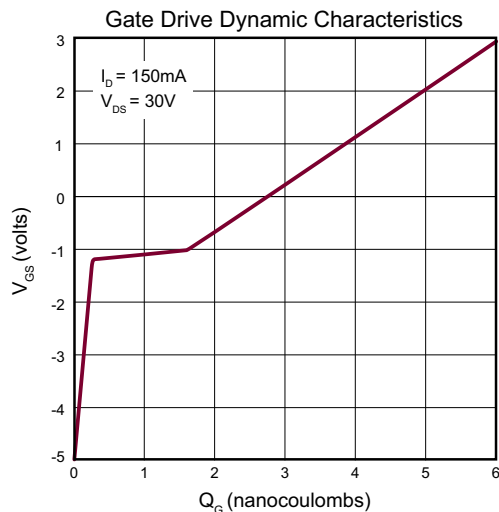
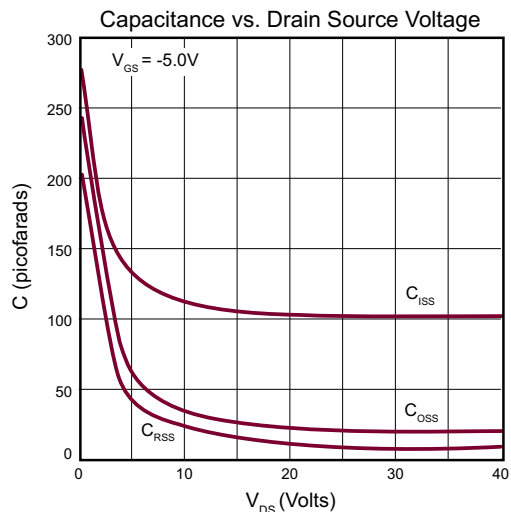
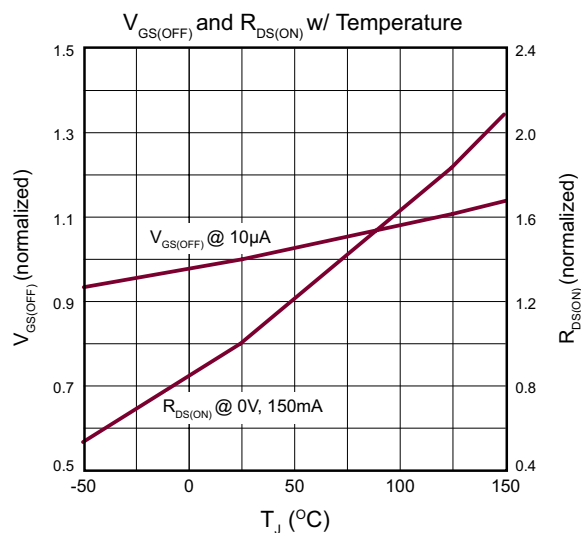
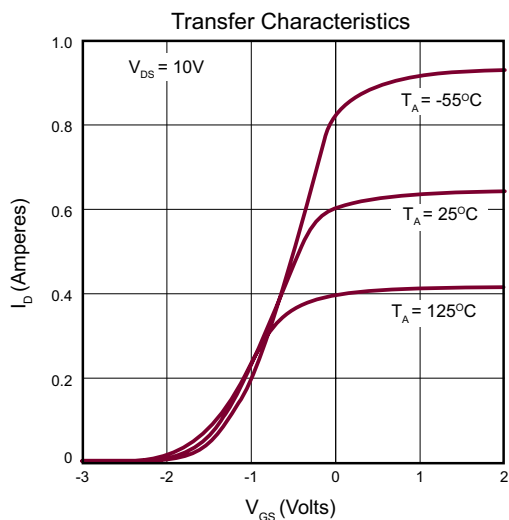
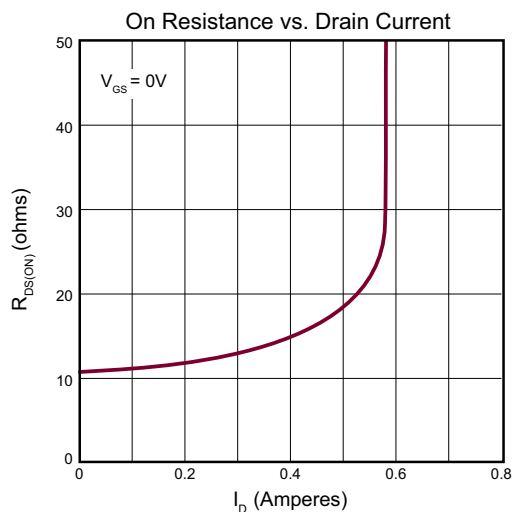
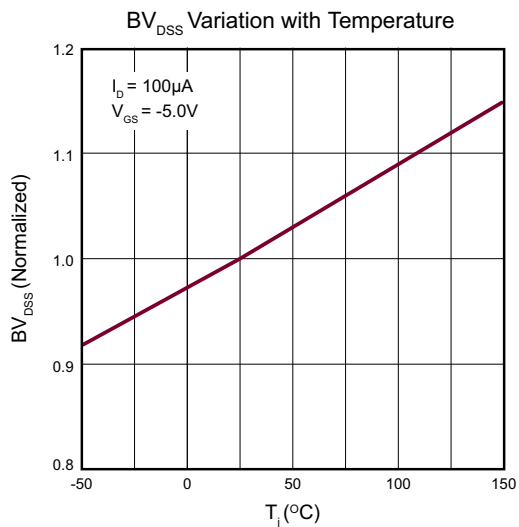
Switching Waveforms and Test Circuit



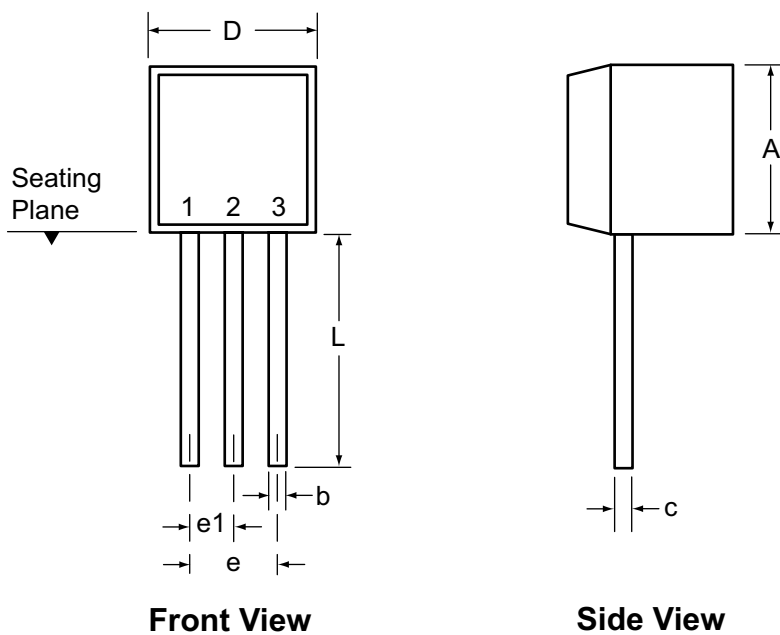
Typical Performance Curves



Typical Performance Curves (cont.)

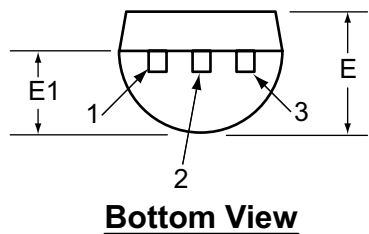


3-Lead TO-92 Package Outline (N3)



Front View

Side View



Bottom View

Symbol	A	b	c	D	E	E1	e	e1	L	
Dimensions (inches)	MIN	.170	.014 [†]	.014 [†]	.175	.125	.080	.095	.045	.500
	NOM	-	-	-	-	-	-	-	-	-
	MAX	.210	.022 [†]	.022 [†]	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.

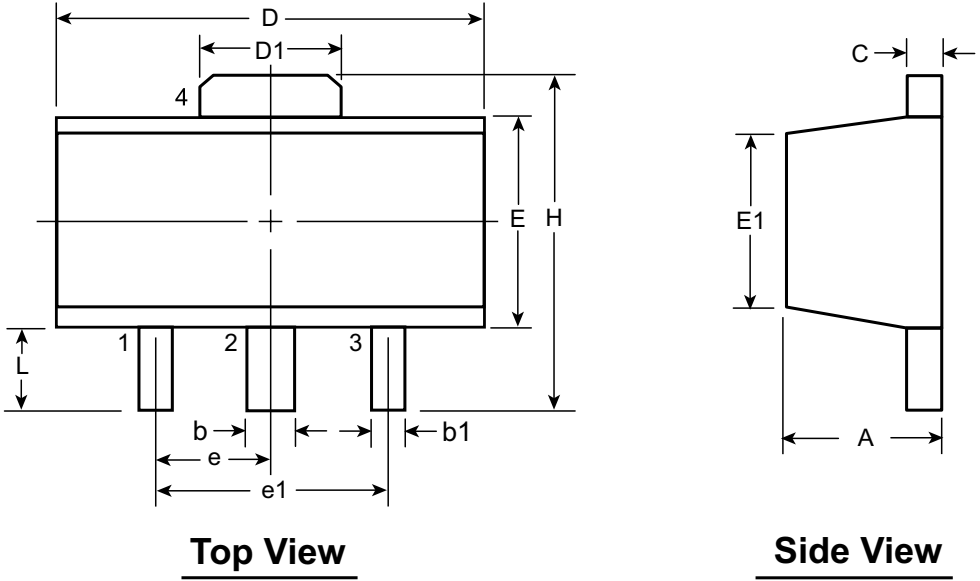
* This dimension is not specified in the JEDEC drawing.

† This dimension differs from the JEDEC drawing.

Drawings not to scale.

Supertex Doc.#: DSPD-3TO92N3, Version E041009.

3-Lead TO-243AA (SOT-89) Package Outline (N8)



Top View

Side View

Symbol	A	b	b1	C	D	D1	E	E1	e	e1	H	L		
Dimensions (mm)	MIN	1.40	0.44	0.36	0.35	4.40	1.62	2.29	2.00†	1.50 BSC	3.00 BSC	3.94	0.89	
	NOM	-	-	-	-	-	-	-	-			-	-	-
	MAX	1.60	0.56	0.48	0.44	4.60	1.83	2.60	2.29			4.25	1.20	

JEDEC Registration TO-243, Variation AA, Issue C, July 1986.

† This dimension differs from the JEDEC drawing

Drawings not to scale.

Supertex Doc. #: DSPD-3TO243AAN8, Version E051509.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <http://www.supertex.com/packaging.html>.)

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